## **IGBT**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

#### **Features**

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- 10 µs Short Circuit Capability
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb-Free Devices

#### **Typical Applications**

- Solar Inverter
- UPS Inverter

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage	$V_{CES}$	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>C</sub>	50 25	А
Pulsed collector current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>CM</sub>	200	Α
Diode forward current @ Tc = 25°C @ Tc = 100°C	l <sub>F</sub>	50 25	Α
Diode pulsed current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>FM</sub>	200	Α
Gate-emitter voltage	$V_{GE}$	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	$P_{D}$	192 77	W
Short Circuit Withstand Time $V_{GE} = 15 \text{ V}, V_{CE} = 500 \text{ V}, T_J \le 150^{\circ}\text{C}$	T <sub>SC</sub>	10	μs
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T <sub>stg</sub>	-55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds(note 3)	T <sub>SLD</sub>	260	°C

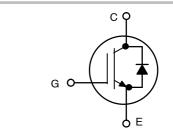
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

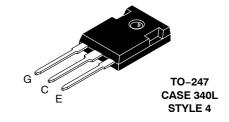


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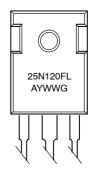
http://onsemi.com

25 A, 1200 V V<sub>CEsat</sub> = 2.0 V E<sub>off</sub> = 0.95 mJ





#### **MARKING DIAGRAM**



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB25N120FLWG	TO-247 (Pb-Free)	30 Units / Rail

### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ hetaJC}$	0.65	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

## **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol Min		Тур	Max	Unit
STATIC CHARACTERISTIC						I
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$	V <sub>(BR)CES</sub>	1200	_	-	V
Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 25 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 25 A, T <sub>J</sub> = 150°C	V <sub>CEsat</sub>	1.55 -	2.0 2.2	2.2	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_{C} = 250 \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V, T <sub>J =</sub> 150°C	I <sub>CES</sub>	- -	- -	0.5 2	mA
Gate leakage current, collector–emitter short–circuited	V <sub>GE</sub> = 20 V , V <sub>CE</sub> = 0 V	I <sub>GES</sub>	-	_	100	nA
DYNAMIC CHARACTERISTIC	•					•
Input capacitance		C <sub>ies</sub>	-	5200	-	pF
Output capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>oes</sub>	-	144	-	1
Reverse transfer capacitance	7	C <sub>res</sub>	-	94	_	
Gate charge total		$Q_g$		220		nC
Gate to emitter charge	V <sub>CE</sub> = 600 V, I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V	Q <sub>ge</sub>		40		
Gate to collector charge	7	Q <sub>gc</sub>		98		
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t <sub>d(on)</sub>		91		ns
Rise time	7	t <sub>r</sub>		26		
Turn-off delay time	Т <sub>Ј</sub> = 25°С	t <sub>d(off)</sub>		228		
Fall time	$V_{CC} = 600 \text{ V}, I_{C} = 25 \text{ A}$ $R_g = 10 \Omega$	t <sub>f</sub>		160		
Turn-on switching loss	V <sub>GE</sub> = 0 V/ 15V	E <sub>on</sub>		1.50		mJ
Turn-off switching loss		E <sub>off</sub>		0.95		
Total switching loss		E <sub>ts</sub>		2.45		
Turn-on delay time		t <sub>d(on)</sub>		88		ns
Rise time	7	t <sub>r</sub>		28		
Turn-off delay time	T <sub>J</sub> = 125°C	t <sub>d(off)</sub>		240		
Fall time	$V_{CC} = 600 \text{ V. } I_{C} = 25 \text{ A}$	t <sub>f</sub>		270		
Turn-on switching loss	$R_g = 10 \Omega$ $V_{GE} = 0 V/ 15V$	E <sub>on</sub>		1.8		mJ
Turn-off switching loss	1	E <sub>off</sub>		1.6		
Total switching loss		E <sub>ts</sub>		3.4		

## **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTIC	•					
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 25 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 25 A, T <sub>J</sub> = 150°C	V <sub>F</sub>		2.2 2.5	2.8	V
Reverse recovery time	T <sub>J</sub> = 25°C	t <sub>rr</sub>		240		ns
Reverse recovery charge	$I_F = 25 \text{ A}, V_R = 400 \text{ V}$ $di_F/dt = 200 \text{ A/}\mu\text{s}$	Q <sub>rr</sub>		1.5		μς
Reverse recovery current		I <sub>rrm</sub>		15		Α
Reverse recovery time	T <sub>J</sub> = 125°C	t <sub>rr</sub>		260		ns
Reverse recovery charge	$I_F = 25 \text{ A}, V_R = 400 \text{ V}$ $di_F/dt = 200 \text{ A/}\mu\text{s}$	Q <sub>rr</sub>		2.0		μς
Reverse recovery current		I <sub>rrm</sub>		19		Α

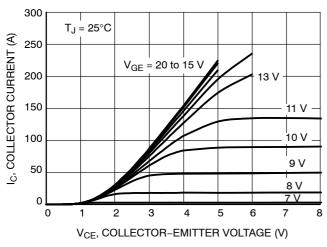


Figure 1. Output Characteristics

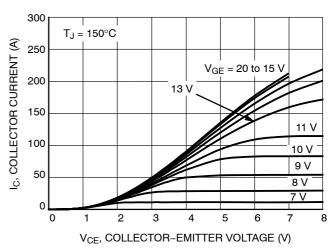


Figure 2. Output Characteristics

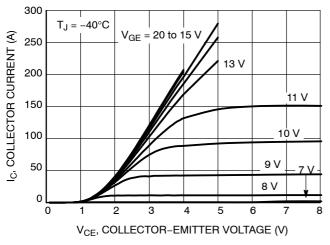


Figure 3. Output Characteristics

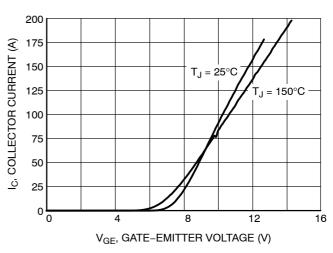


Figure 4. Typical Transfer Characteristics

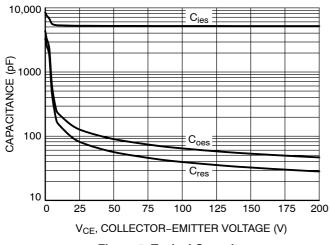


Figure 5. Typical Capacitance

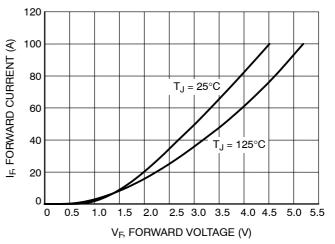


Figure 6. Diode Forward Characteristics

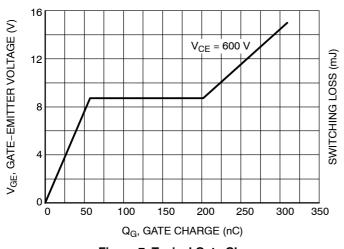


Figure 7. Typical Gate Charge

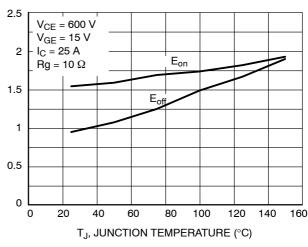


Figure 8. Energy Loss vs. Temperature

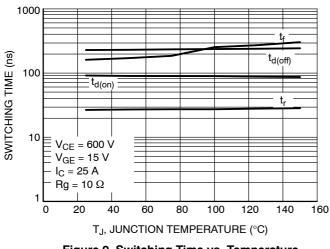


Figure 9. Switching Time vs. Temperature

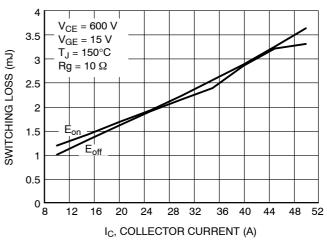


Figure 10. Energy Loss vs. I<sub>C</sub>

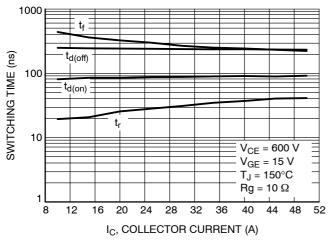


Figure 11. Switching Time vs. I<sub>C</sub>

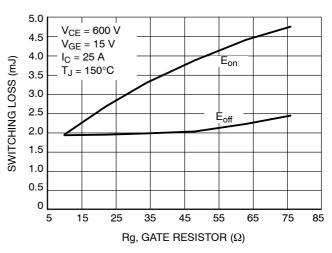


Figure 12. Energy Loss vs. Rg

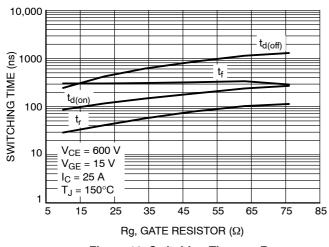


Figure 13. Switching Time vs. Rg

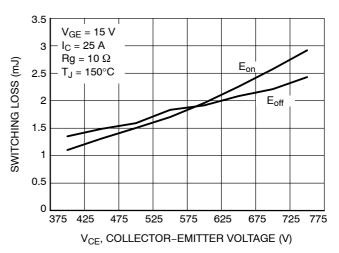


Figure 14. Energy Loss vs. V<sub>CE</sub>

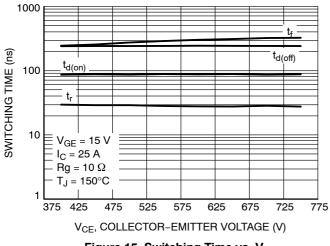


Figure 15. Switching Time vs. V<sub>CE</sub>

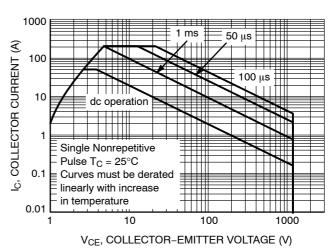


Figure 16. Safe Operating Area

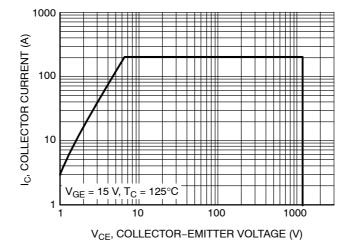


Figure 17. Reverse Bias Safe Operating Area

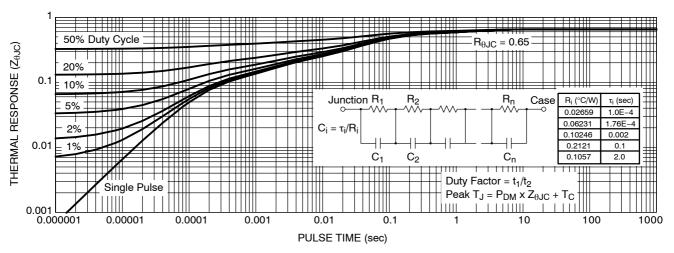


Figure 18. IGBT Transient Thermal Impedance

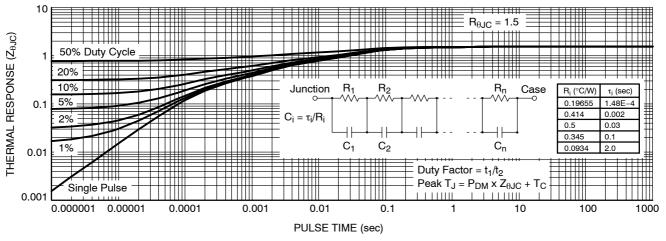


Figure 19. Diode Transient Thermal Impedance

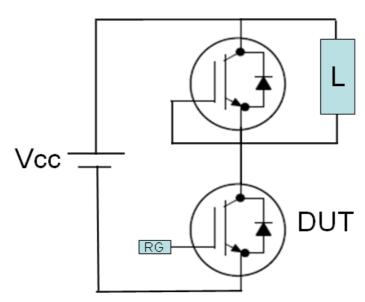


Figure 20. Test Circuit for Switching Characteristics

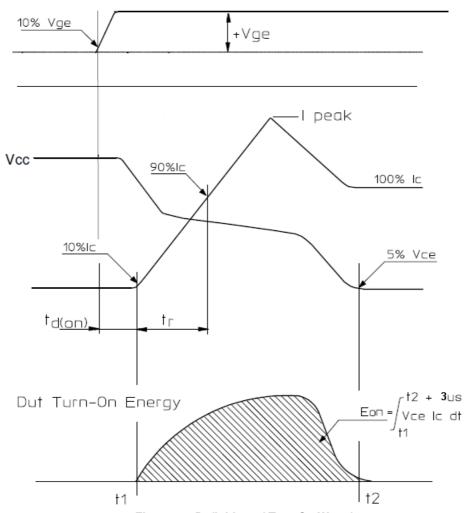


Figure 21. Definition of Turn On Waveform

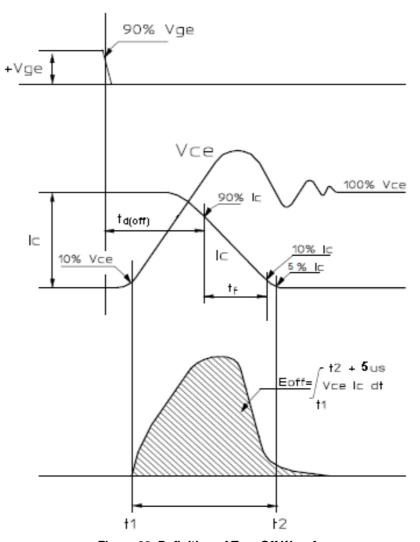
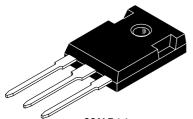


Figure 22. Definition of Turn Off Waveform





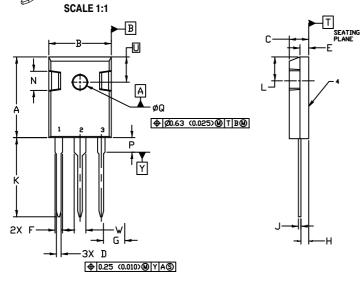
TO-247 CASE 340L ISSUE G

**DATE 06 OCT 2021** 

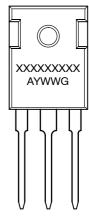
#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Ε	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
К	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	6.15 BSC		BSC
W	2.87	3.12	0.113	0.123



# GENERIC MARKING DIAGRAM\*



 STYLE 1:
 STYLE 2:
 STYLE 2:

 PIN 1. GATE
 PIN 1. ANODE
 2. CATHODE (S)

 2. DRAIN
 2. CATHODE (S)
 3. ANODE 2

 4. DRAIN
 4. CATHODES (S)

STYLE 6:

PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

3. GATE 4. MAIN TERMINAL 2

STYLE 5:

PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE 
 STYLE 3:
 STYLE 4:

 PIN 1. BASE
 PIN 1. GATE

 2. COLLECTOR
 2. COLLECTOR

 3. EMITTER
 3. EMITTER

 4. COLLECTOR
 4. COLLECTOR

XXXXX = Specific Device Code A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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 GT50JR22(STA1ES)
 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
 NGTG15N120FL2WG
 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

 IKZA40N65RH5XKSA1
 IKFW75N65ES5XKSA1
 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

 IKFW60N65ES5XKSA1
 IMBG120R090M1HXTMA1
 IMBG120R220M1HXTMA1
 XD15H120CX1
 XD25H120CX0
 XP15PJS120CL1B1

 IGW30N60H3FKSA1
 STGWA8M120DF3
 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD\_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1